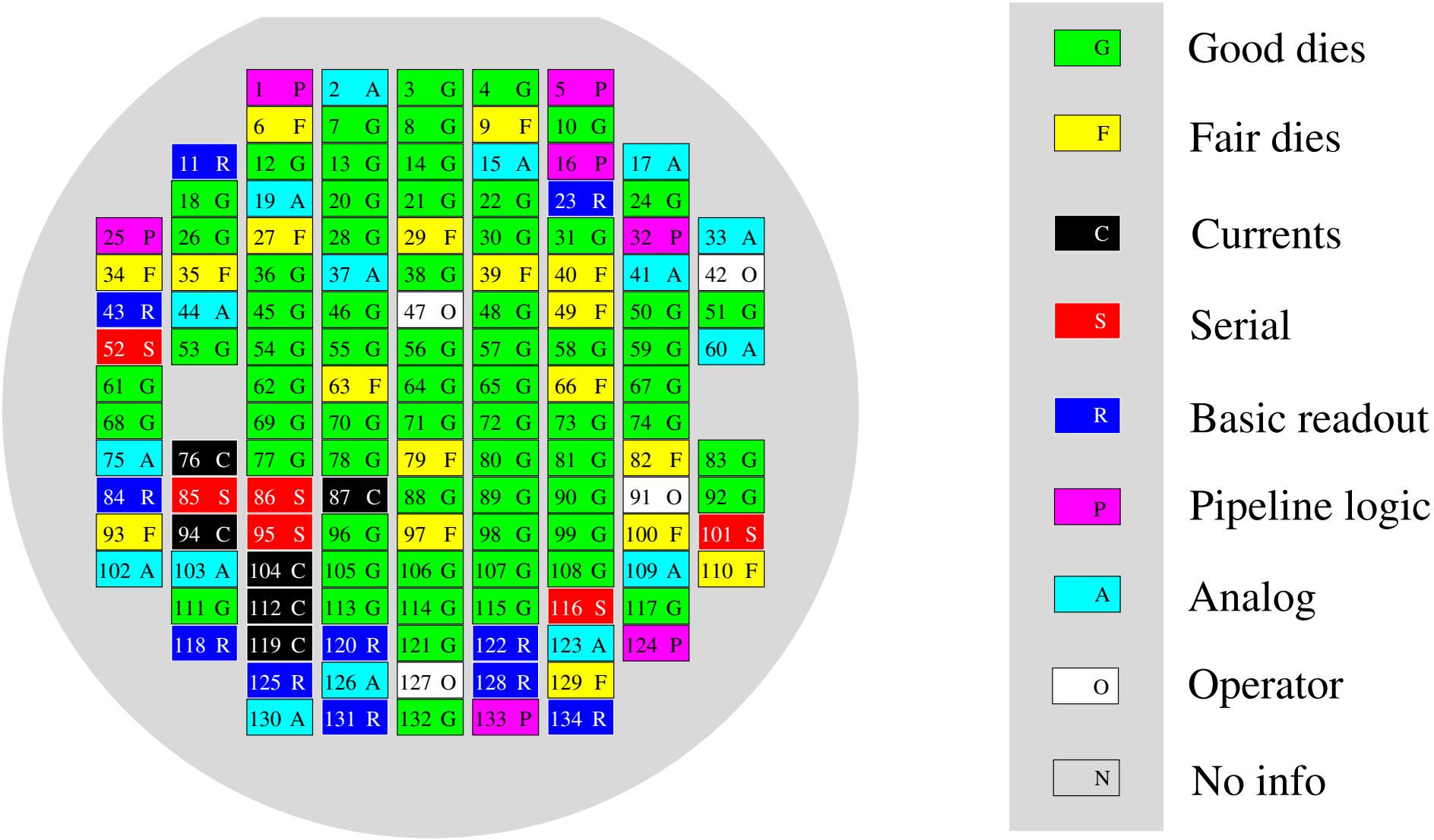
Types of die failures for wafer 228 s/n: 21316-14-19

Date: 10/27/99